DB4X314K

Silicon epitaxial planar type

For high speed switching circuits

■ Features

- Short reverse recovery time t_{rr}
- Small reverse current I_R
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

■ Basic Part Number

Dual DB2J314 (Parallel)

Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse voltage		V _R	30	V	
Maximum peak reverse voltage		V_{RM}	30	V	
Forward current	Single		30	mA	
	Double *	I_{F}	20		
D 1 C 1	Single		150	mA	
Peak forward current	Double *	I_{FM}	110		
Junction temperature		T _j	125	°C	
Storage temperature		T _{stg}	-55 to +125	°C	

Note) *: Value of each diode in double diodes used.

■ Package

• Code

Mini4-G4-B

• Pin Name

1: Anode-1 3: Cathode-2 2: Anode-2 4: Cathode-1

■ Marking Symbol: 4X

■ Internal Connection

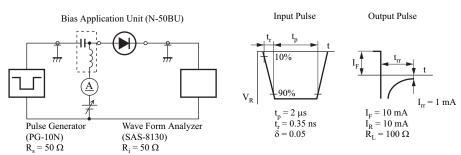


■ Electrical Characteristics $T_a = 25$ °C±3°C

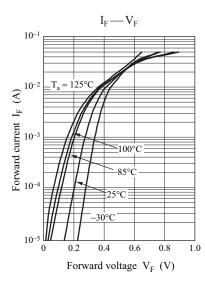
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{F1}	$I_F = 1 \text{ mA}$			0.40	V
	V_{F2}	$I_F = 30 \text{ mA}$			1.0	
Reverse current	I_R	$V_R = 30 \text{ V}$			300	nA
Terminal capacitance	C _t	$V_R = 10 \text{ V}, f = 1 \text{ MHz}$		1.5		pF
Reverse recovery time *	t _{rr}	$\begin{aligned} & I_F = I_R = 10 \text{ mA}, I_{rr} = 1 \text{ mA}, \\ & R_L = 100 \Omega \end{aligned}$		1.0		ns

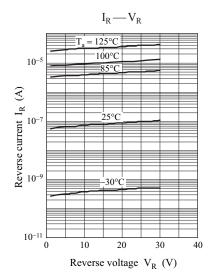
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

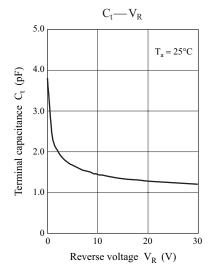
- 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
- 3. *: t_{rr} measurement circuit



DB4X314K Panasonic

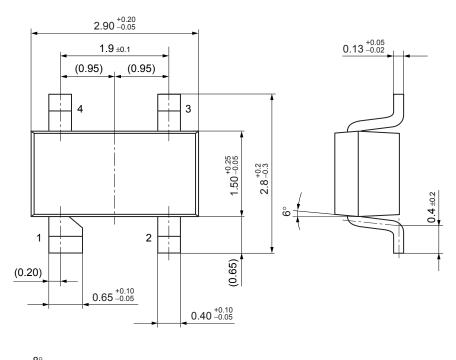


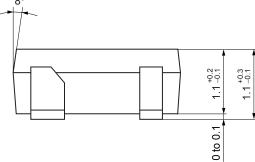




2 Ver. BED

Mini4-G4-B Unit: mm





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